MSKSEMI 美森科













ESD

3

TSS

MOV

GDT

PLED

WPM3407-MS

Product specification





P-Channel Enhancement Mode Power MOSFET

General Features

- $V_{DS} = -30V, I_{D} = -4.1A$
- $R_{DS(ON)} < 95m\Omega @ V_{GS}=-4.5V$
- $R_{DS(ON)}$ < 65m Ω @ V_{GS} =-10V

High power and current handing capability Lead free product is acquired Surface mount package

Application

- PWM applications
- Load switch
- Power management

Reference News

PACKAGE OUTLINE	PIN Configuration	Marking
SOT-23	G	A79T

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ь	-4.1	Α
Drain Current-Pulsed (Note 1)	І рм	-20	Α
Maximum Power Dissipation	P _D	1.4	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	${\mathbb C}$

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note 2)	Reja	90	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-30	-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	VDS=-24V,VGS=0V	-	-	-1	μA



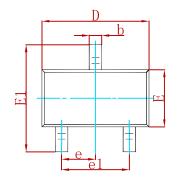
Symbol	Condition	Min	Тур	Max	Unit	
lgss	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)						
V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	-1	-1.5	-3	V	
_	V _{GS} =-10V, I _D =-4.1A	-	48	65	mΩ	
KDS(ON)	V _{GS} =-4.5V, I _D =-4A	-	60	95	mΩ	
grs	V _{DS} =-5V,I _D =-4.1A	5.5	-	-	S	
'		·	1			
Clss		-	650	-	PF	
Coss	·	-	105	-	PF	
Crss	V, F=1.0MHz		65	-	PF	
		'				
t _{d(on)}		-	8.5	-	nS	
t _r	V _{DD} =-15V,R _L =3.6	-	4.5	-	nS	
t _{d(off)}	ΩVGS	-	26	-	nS	
t _f	=-10V,R _{GEN} =3Ω	-	12.5	-	nS	
Qg		-	12.5	-	nC	
Qgs	V _{DS} =-15V,I _D =-4A,V _{GS} =-10	-	2.8	-	nC	
Qgd	1 V	-	2.7	-	nC	
Drain-Source Diode Characteristics						
VsD	V _{GS} =0V,I _S =-4.1A	-	-	-1.2	V	
	IGSS VGS(th) RDS(ON) GFS CISS Coss Crss td(on) tr td(off) tf Qg Qgs Qgs Qgd	IGSS VGS=±20V,VDS=0V VGS(th) VDS=VGS,ID=-250μA VGS=-10V, ID=-4.1A VGS=-4.5V, ID=-4A VDS=-5V,ID=-4.1A VDS=-5V,ID=-4.1A VDS=-15V,VGS=0 VDS=-15V,RL=3.6 VDS=-15V,RL=3.6 VDS=-15V,RL=3.6 VDS=-15V,RL=3.6 VDS=-15V,RL=3.6 VDS=-15V,RL=3.6 VDS=-15V,RL=3.6 VDS=-15V,RL=3.6 VDS=-15V,RL=3.6 VDS=-15V,RD=-4A,VGS=-10 VDS=-15V,ID=-4A,VGS=-10 VDS=-15V,ID=-4A,VG	IGSS VGS=±20V,VDS=0V -	IGSS VGS=±20V,VDS=0V - - -	IGSS	

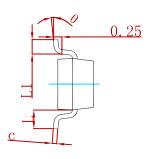
Notes:

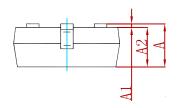
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2\%$.
- 4. Guaranteed by design, not subject to production



PACKAGE MECHANICAL DATA

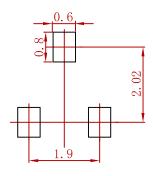






Cumbal	Dimensions In Millimeters		Dimension	s In Inches
Symbol	Min	Max	Min	Max
Α	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
С	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
Е	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
е	0.950	0.950 TYP		7 TYP
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

Suugested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
WPM3407-MS	SOT-23	3000



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